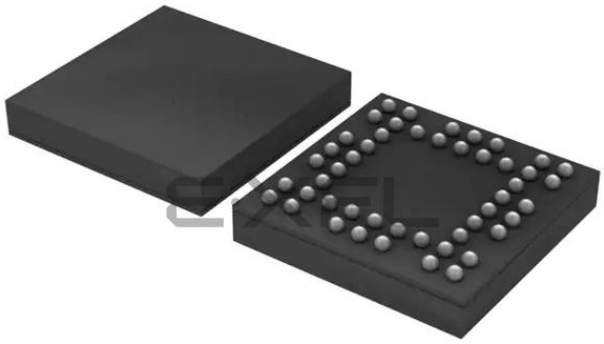

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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

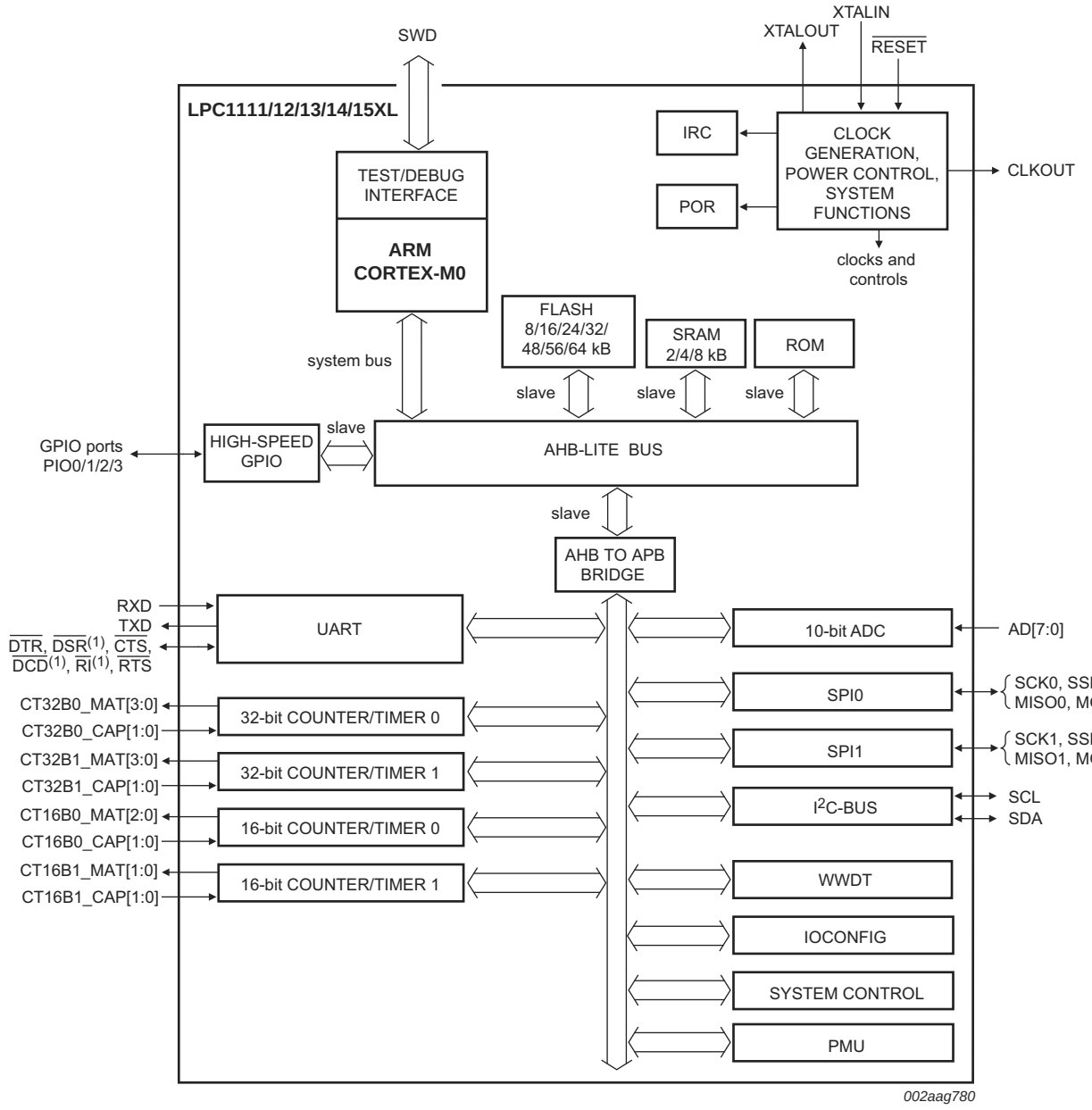
Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	ARM® Cortex®-M0
Core Size	32-Bit Single-Core
Speed	50MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	42
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	48-TFBGA
Supplier Device Package	48-TFBGA (4.5x4.5)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/lpc1115jet48-303ql

- Digital peripherals:
  - Up to 42 General Purpose I/O (GPIO) pins with configurable pull-up/pull-down resistors. In addition, a configurable open-drain mode is supported on the LPC1100L and LPC1100XL series.
  - GPIO pins can be used as edge and level sensitive interrupt sources.
  - High-current output driver (20 mA) on one pin.
  - High-current sink drivers (20 mA) on two I^2C-bus pins in Fast-mode Plus (not on LPC1112FDH20/102).
  - Four general purpose counter/timers with up to eight capture inputs and up to 13 match outputs.
  - Programmable WatchDog Timer (WDT) the LPC1100 series only.
  - Programmable windowed WDT on the LPC1100L and LPC1100XL series only.
- Analog peripherals:
  - 10-bit ADC with input multiplexing among 5, 6, or 8 pins depending on package size.
- Serial interfaces:
  - UART with fractional baud rate generation, internal FIFO, and RS-485 support.
  - Two SPI controllers with SSP features and with FIFO and multi-protocol capabilities (second SPI on LPC1100 and LPC1100L series LQFP48 package only).
  - I^2C-bus interface supporting full I^2C-bus specification and Fast-mode Plus with a data rate of 1 Mbit/s with multiple address recognition and monitor mode (not on LPC1112FDH20/102).
- Clock generation:
  - 12 MHz internal RC oscillator trimmed to 1 % accuracy that can optionally be used as a system clock.
  - Crystal oscillator with an operating range of 1 MHz to 25 MHz.
  - Programmable watchdog oscillator with a frequency range of 9.4 kHz to 2.3 MHz.
  - PLL allows CPU operation up to the maximum CPU rate without the need for a high-frequency crystal. May be run from the system oscillator or the internal RC oscillator.
  - Clock output function with divider that can reflect the system oscillator clock, IRC clock, CPU clock, and the Watchdog clock.
- Power control:
  - Integrated PMU (Power Management Unit) to minimize power consumption during Sleep, Deep-sleep, and Deep power-down modes.
  - Power profiles residing in boot ROM allowing to optimize performance and minimize power consumption for any given application through one simple function call. (LPC1100L and LPC1100XL series only.)
  - Three reduced power modes: Sleep, Deep-sleep, and Deep power-down.
  - Processor wake-up from Deep-sleep mode via a dedicated start logic using up to 13 of the functional pins.
  - Power-On Reset (POR).
  - Brownout detect with up to four separate thresholds for interrupt and forced reset.
- Unique device serial number for identification.
- Single power supply (1.8 V to 3.6 V).
- Available as LQFP48 package, HVQFN33 package, and TFBGA48 package.

Table 2. Ordering options *…continued*

Type number	Series	Flash	Total SRAM	Power profiles	UART	I^2C/ Fast+	SPI	ADC channel	GPIO	Package	Temp[1]
LPC1113											
LPC1113FHN33/201	LPC1100	24 kB	4 kB	no	1	1	1	8	28	HVQFN33	F
LPC1113FHN33/202	LPC1100L	24 kB	4 kB	yes	1	1	1	8	28	HVQFN33	F
LPC1113FHN33/203	LPC1100XL	24 kB	4 kB	yes	1	1	2	8	28	HVQFN33	F
LPC1113JHN33/203	LPC1100XL	24 kB	4 kB	yes	1	1	2	8	28	HVQFN33	J
LPC1113FHN33/301	LPC1100	24 kB	8 kB	no	1	1	1	8	28	HVQFN33	F
LPC1113FHN33/302	LPC1100L	24 kB	8 kB	yes	1	1	1	8	28	HVQFN33	F
LPC1113FHN33/303	LPC1100XL	24 kB	8 kB	yes	1	1	2	8	28	HVQFN33	F
LPC1113JHN33/303	LPC1100XL	24 kB	8 kB	yes	1	1	2	8	28	HVQFN33	J
LPC1113FBD48/301	LPC1100	24 kB	8 kB	no	1	1	2	8	42	LQFP48	F
LPC1113FBD48/302	LPC1100L	24 kB	8 kB	yes	1	1	2	8	42	LQFP48	F
LPC1113FBD48/303	LPC1100XL	24 kB	8 kB	yes	1	1	2	8	42	LQFP48	F
LPC1113JBD48/303	LPC1100XL	24 kB	8 kB	yes	1	1	2	8	42	LQFP48	J
LPC1114											
LPC1114FDH28/102	LPC1100L	32 kB	4 kB	yes	1	1	1	6	22	TSSOP28	F
LPC1114FN28/102	LPC1100L	32 kB	4 kB	yes	1	1	1	6	22	DIP28	F
LPC1114FHN33/201	LPC1100	32 kB	4 kB	no	1	1	1	8	28	HVQFN33	F
LPC1114FHN33/202	LPC1100L	32 kB	4 kB	yes	1	1	1	8	28	HVQFN33	F
LPC1114FHN33/203	LPC1100XL	32 kB	4 kB	yes	1	1	2	8	28	HVQFN33	F
LPC1114JHN33/203	LPC1100XL	32 kB	4 kB	yes	1	1	2	8	28	HVQFN33	J
LPC1114FHN33/301	LPC1100	32 kB	8 kB	no	1	1	1	8	28	HVQFN33	F
LPC1114FHN33/302	LPC1100L	32 kB	8 kB	yes	1	1	1	8	28	HVQFN33	F
LPC1114FHN33/303	LPC1100XL	32 kB	8 kB	yes	1	1	2	8	28	HVQFN33	F
LPC1114JHN33/303	LPC1100XL	32 kB	8 kB	yes	1	1	2	8	28	HVQFN33	J
LPC1114FHN33/333	LPC1100XL	56 kB	8 kB	yes	1	1	2	8	28	HVQFN33	F
LPC1114JHN33/333	LPC1100XL	56 kB	8 kB	yes	1	1	2	8	28	HVQFN33	J
LPC1114FHI33/302	LPC1100L	32 kB	8 kB	yes	1	1	1	8	28	HVQFN33	F
LPC1114FHI33/303	LPC1100XL	32 kB	8 kB	yes	1	1	2	8	28	HVQFN33	F
LPC1114JHI33/303	LPC1100XL	32 kB	8 kB	yes	1	1	2	8	28	HVQFN33	J
LPC1114FBD48/301	LPC1100	32 kB	8 kB	no	1	1	2	8	42	LQFP48	F
LPC1114FBD48/302	LPC1100L	32 kB	8 kB	yes	1	1	2	8	42	LQFP48	F
LPC1114FBD48/303	LPC1100XL	32 kB	8 kB	yes	1	1	2	8	42	LQFP48	F
LPC1114JBD48/303	LPC1100XL	32 kB	8 kB	yes	1	1	2	8	42	LQFP48	J
LPC1114FBD48/323	LPC1100XL	48 kB	8 kB	yes	1	1	2	8	42	LQFP48	F
LPC1114JBD48/323	LPC1100XL	48 kB	8 kB	yes	1	1	2	8	42	LQFP48	J
LPC1114FBD48/333	LPC1100XL	56 kB	8 kB	yes	1	1	2	8	42	LQFP48	F
LPC1114JBD48/333	LPC1100XL	56 kB	8 kB	yes	1	1	2	8	42	LQFP48	J
LPC1115											
LPC1115FBD48/303	LPC1100XL	64 kB	8 kB	yes	1	1	2	8	42	LQFP48	F



(1) LQFP48 and TFBGA48 only.

Fig 2. LPC1100XL series block diagram

Table 4. LPC1100L series: LPC1110/11/12 pin description table (SO20 and TSSOP20 package with I²C-bus pins) *…continued*

Symbol	Pin SO20/ TSSOP20	Start logic input	Type	Reset state [1]	Description
R/PIO0_11/ AD0/CT32B0_MAT3	4 [5]	yes	I	I; PU	**R —** Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	**PIO0_11 —** General purpose digital input/output pin.
			I	-	**AD0 —** A/D converter, input 0.
			O	-	**CT32B0_MAT3 —** Match output 3 for 32-bit timer 0.
PIO1_0 to PIO1_7			I/O		**Port 1 —** Port 1 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 1 pins depends on the function selected through the IOCONFIG register block.
R/PIO1_0/ AD1/CT32B1_CAP0	7 [5]	yes	I	I; PU	**R —** Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	**PIO1_0 —** General purpose digital input/output pin.
			I	-	**AD1 —** A/D converter, input 1.
			I	-	**CT32B1_CAP0 —** Capture input 0 for 32-bit timer 1.
R/PIO1_1/ AD2/CT32B1_MAT0	8 [5]	no	O	I; PU	**R —** Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	**PIO1_1 —** General purpose digital input/output pin.
			I	-	**AD2 —** A/D converter, input 2.
			O	-	**CT32B1_MAT0 —** Match output 0 for 32-bit timer 1.
R/PIO1_2/ AD3/CT32B1_MAT1	9 [5]	no	I	I; PU	**R —** Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	**PIO1_2 —** General purpose digital input/output pin.
			I	-	**AD3 —** A/D converter, input 3.
			O	-	**CT32B1_MAT1 —** Match output 1 for 32-bit timer 1.
SWDIO/PIO1_3/ AD4/CT32B1_MAT2	10 [5]	no	I/O	I; PU	**SWDIO —** Serial wire debug input/output.
			I/O	-	**PIO1_3 —** General purpose digital input/output pin.
			I	-	**AD4 —** A/D converter, input 4.
			O	-	**CT32B1_MAT2 —** Match output 2 for 32-bit timer 1.
PIO1_6/RXD/ CT32B0_MAT0	11 [3]	no	I/O	I; PU	**PIO1_6 —** General purpose digital input/output pin.
			I	-	**RXD —** Receiver input for UART.
			O	-	**CT32B0_MAT0 —** Match output 0 for 32-bit timer 0.
PIO1_7/TXD/ CT32B0_MAT1	12 [3]	no	I/O	I; PU	**PIO1_7 —** General purpose digital input/output pin.
			O	-	**TXD —** Transmitter output for UART.
			O	-	**CT32B0_MAT1 —** Match output 1 for 32-bit timer 0.
V_{DD}	15	-		-	3.3 V supply voltage to the internal regulator, the external rail, and the ADC. Also used as the ADC reference voltage.
XTALIN	14 [6]	-	I	-	Input to the oscillator circuit and internal clock generator circuits. Input voltage must not exceed 1.8 V.
XTALOUT	13 [6]	-	O	-	Output from the oscillator amplifier.
V_{SS}	16	-		-	Ground.

Table 6. LPC1100L series: LPC1112 (HVQFN24 package) *…continued*

Symbol	HVQFN pin	Start logic input	Type	Reset state [1]	Description
SWDIO/PIO1_3/ AD4/CT32B1_MAT2	19[5]	no	I/O	I; PU	**SWDIO —** Serial wire debug input/output.
			I/O	-	**PIO1_3 —** General purpose digital input/output pin.
			I	-	**AD4 —** A/D converter, input 4.
			O	-	**CT32B1_MAT2 —** Match output 2 for 32-bit timer 1.
PIO1_4/AD5/ CT32B1_MAT3/ WAKEUP	20[5]	no	I/O	I; PU	**PIO1_4 —** General purpose digital input/output pin with 10 ns glitch filter. In Deep power-down mode, this pin serves as the Deep power-down mode wake-up pin with 20 ns glitch filter. Pull this pin HIGH externally before entering Deep power-down mode. Pull this pin LOW to exit Deep power-down mode. A LOW-going pulse as short as 50 ns wakes up the part.
			I	-	**AD5 —** A/D converter, input 5.
			O	-	**CT32B1_MAT3 —** Match output 3 for 32-bit timer 1.
PIO1_6/RXD/ CT32B0_MAT0	23[3]	no	I/O	I; PU	**PIO1_6 —** General purpose digital input/output pin.
			I	-	**RXD —** Receiver input for UART.
			O	-	**CT32B0_MAT0 —** Match output 0 for 32-bit timer 0.
PIO1_7/TXD/ CT32B0_MAT1	24[3]	no	I/O	I; PU	**PIO1_7 —** General purpose digital input/output pin.
			O	-	**TXD —** Transmitter output for UART.
			O	-	**CT32B0_MAT1 —** Match output 1 for 32-bit timer 0.
PIO1_8/ CT16B1_CAP0	6[3]	no	I/O	I; PU	**PIO1_8 —** General purpose digital input/output pin.
			I	-	**CT16B1_CAP0 —** Capture input 0 for 16-bit timer 1.
XTALIN	4[6]	-	I	-	Input to the oscillator circuit and internal clock generator circuits. Input voltage must not exceed 1.8 V.
V_{DD}	5; 22	-	I	-	1.8 V supply voltage to the internal regulator, the external rail, and the ADC. Also used as the ADC reference voltage.
V_{SS}	3; 21	-	I	-	Ground.

[1] Pin state at reset for default function: I = Input; O = Output; PU = internal pull-up enabled (pins pulled up to full V_{DD} level); IA = inactive, no pull-up/down enabled.

[2] 5 V tolerant pad. $\overline{\text{RESET}}$ functionality is not available in Deep power-down mode. Use the WAKEUP pin to reset the chip and wake up from Deep power-down mode. An external pull-up resistor is required on this pin for the Deep power-down mode. See Figure 52 for the reset pad configuration.

[3] Pad providing digital I/O functions with configurable pull-up/pull-down resistors and configurable hysteresis (see Figure 51).

[4] I^2C-bus pads compliant with the I^2C-bus specification for I^2C standard mode and I^2C Fast-mode Plus. The pin requires an external pull-up to provide output functionality. When power is switched off, this pin is floating and does not disturb the I2C lines. Open-drain configuration applies to all functions on this pin.

[5] Pad providing digital I/O functions with configurable pull-up/pull-down resistors, configurable hysteresis, and analog input. When configured as a ADC input, digital section of the pad is disabled (see Figure 51).

[6] When the system oscillator is not used, connect XTALIN and XTALOUT as follows: XTALIN can be left floating or can be grounded (grounding is preferred to reduce susceptibility to noise). XTALOUT should be left floating.

Table 8. LPC1100 and LPC1100L series: LPC1113/14 pin description table (LQFP48 package)

Symbol	Pin	Start logic input	Type	Reset state [1]	Description
PIO0_0 to PIO0_11			I/O		**Port 0 —** Port 0 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 0 pins depends on the function selected through the IOCONFIG register block.
$\overline{\text{RESET}}$/PIO0_0	3[2]	yes	I	I; PU	**$\overline{\text{RESET}}$ —** External reset input with 20 ns glitch filter. A LOW-going pulse as short as 50 ns on this pin resets the device, causing I/O ports and peripherals to take on their default states, and processor execution to begin at address 0. In deep power-down mode, this pin must be pulled HIGH externally. The $\overline{\text{RESET}}$ pin can be left unconnected or be used as a GPIO pin if an external $\overline{\text{RESET}}$ function is not needed and Deep power-down mode is not used.
			I/O	-	**PIO0_0 —** General purpose digital input/output pin with 10 ns glitch filter.
PIO0_1/CLKOUT/ CT32B0_MAT2	4[3]	yes	I/O	I; PU	**PIO0_1 —** General purpose digital input/output pin. A LOW level on this pin during reset starts the ISP command handler.
			O	-	**CLKOUT —** Clockout pin.
			O	-	**CT32B0_MAT2 —** Match output 2 for 32-bit timer 0.
PIO0_2/SSEL0/ CT16B0_CAP0	10[3]	yes	I/O	I; PU	**PIO0_2 —** General purpose digital input/output pin.
			I/O	-	**SSEL0 —** Slave Select for SPI0.
			I	-	**CT16B0_CAP0 —** Capture input 0 for 16-bit timer 0.
PIO0_3	14[3]	yes	I/O	I; PU	**PIO0_3 —** General purpose digital input/output pin.
PIO0_4/SCL	15[4]	yes	I/O	I; IA	**PIO0_4 —** General purpose digital input/output pin (open-drain).
			I/O	-	**SCL —** I^2C-bus, open-drain clock input/output. High-current sink only if I^2C Fast-mode Plus is selected in the I/O configuration register.
PIO0_5/SDA	16[4]	yes	I/O	I; IA	**PIO0_5 —** General purpose digital input/output pin (open-drain).
			I/O	-	**SDA —** I^2C-bus, open-drain data input/output. High-current sink only if I^2C Fast-mode Plus is selected in the I/O configuration register.
PIO0_6/SCK0	22[3]	yes	I/O	I; PU	**PIO0_6 —** General purpose digital input/output pin.
			I/O	-	**SCK0 —** Serial clock for SPI0.
PIO0_7/$\overline{\text{CTS}}$	23[3]	yes	I/O	I; PU	**PIO0_7 —** General purpose digital input/output pin (high-current output driver).
			I	-	**$\overline{\text{CTS}}$ —** Clear To Send input for UART.
PIO0_8/MISO0/ CT16B0_MAT0	27[3]	yes	I/O	I; PU	**PIO0_8 —** General purpose digital input/output pin.
			I/O	-	**MISO0 —** Master In Slave Out for SPI0.
			O	-	**CT16B0_MAT0 —** Match output 0 for 16-bit timer 0.
PIO0_9/MOSI0/ CT16B0_MAT1	28[3]	yes	I/O	I; PU	**PIO0_9 —** General purpose digital input/output pin.
			I/O	-	**MOSI0 —** Master Out Slave In for SPI0.
			O	-	**CT16B0_MAT1 —** Match output 1 for 16-bit timer 0.

Table 9. LPC1100 and LPC1100L series: LPC1111/12/13/14 pin description table (HVQFN33 package)

Symbol	Pin	Start logic input	Type	Reset state [1]	Description
PIO0_0 to PIO0_11					**Port 0 —** Port 0 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 0 pins depends on the function selected through the IOCONFIG register block.
$\overline{\text{RESET}}$/PIO0_0	2[2]	yes	I	I;PU	**$\overline{\text{RESET}}$ —** External reset input with 20 ns glitch filter. A LOW-going pulse as short as 50 ns on this pin resets the device, causing I/O ports and peripherals to take on their default states and processor execution to begin at address 0. In deep power-down mode, this pin must be pulled HIGH externally. The $\overline{\text{RESET}}$ pin can be left unconnected or be used as a GPIO pin if an external $\overline{\text{RESET}}$ function is not needed and Deep power-down mode is not used.
			I/O	-	**PIO0_0 —** General purpose digital input/output pin with 10 ns glitch filter.
PIO0_1/CLKOUT/ CT32B0_MAT2	3[3]	yes	I/O	I;PU	**PIO0_1 —** General purpose digital input/output pin. A LOW level on this pin during reset starts the ISP command handler.
			O	-	**CLKOUT —** Clock out pin.
			O	-	**CT32B0_MAT2 —** Match output 2 for 32-bit timer 0.
PIO0_2/SSEL0/ CT16B0_CAP0	8[3]	yes	I/O	I;PU	**PIO0_2 —** General purpose digital input/output pin.
			I/O	-	**SSEL0 —** Slave select for SPI0.
			I	-	**CT16B0_CAP0 —** Capture input 0 for 16-bit timer 0.
PIO0_3	9[3]	yes	I/O	I;PU	**PIO0_3 —** General purpose digital input/output pin.
PIO0_4/SCL	10[4]	yes	I/O	I;IA	**PIO0_4 —** General purpose digital input/output pin (open-drain).
			I/O	-	**SCL —** I^2C-bus, open-drain clock input/output. High-current sink only if I^2C Fast-mode Plus is selected in the I/O configuration register.
PIO0_5/SDA	11[4]	yes	I/O	I;IA	**PIO0_5 —** General purpose digital input/output pin (open-drain).
			I/O	-	**SDA —** I^2C-bus, open-drain data input/output. High-current sink only if I^2C Fast-mode Plus is selected in the I/O configuration register.
PIO0_6/SCK0	15[3]	yes	I/O	I;PU	**PIO0_6 —** General purpose digital input/output pin.
			I/O	-	**SCK0 —** Serial clock for SPI0.
PIO0_7/$\overline{\text{CTS}}$	16[3]	yes	I/O	I;PU	**PIO0_7 —** General purpose digital input/output pin (high-current output driver).
			I	-	**$\overline{\text{CTS}}$ —** Clear To Send input for UART.
PIO0_8/MISO0/ CT16B0_MAT0	17[3]	yes	I/O	I;PU	**PIO0_8 —** General purpose digital input/output pin.
			I/O	-	**MISO0 —** Master In Slave Out for SPI0.
			O	-	**CT16B0_MAT0 —** Match output 0 for 16-bit timer 0.
PIO0_9/MOSI0/ CT16B0_MAT1	18[3]	yes	I/O	I;PU	**PIO0_9 —** General purpose digital input/output pin.
			I/O	-	**MOSI0 —** Master Out Slave In for SPI0.
			O	-	**CT16B0_MAT1 —** Match output 1 for 16-bit timer 0.
SWCLK/PIO0_10/ SCK0/ CT16B0_MAT2	19[3]	yes	I	I;PU	**SWCLK —** Serial wire clock.
			I/O	-	**PIO0_10 —** General purpose digital input/output pin.
			I/O	-	**SCK0 —** Serial clock for SPI0.
			O	-	**CT16B0_MAT2 —** Match output 2 for 16-bit timer 0.

Table 10. LPC1100XL series: LPC1113/14/15 pin description table (LQFP48 and TFBGA48 package) *…continued*

Symbol	LQFP48	TFBGA48	Start logic input	Type	Reset state [1]	Description
PIO1_4/AD5/ CT32B1_MAT3/ WAKEUP	40[5]	A6[5]	no	I/O	I; PU	**PIO1_4 —** General purpose digital input/output pin with 10 ns glitch filter. In Deep power-down mode, this pin serves as the Deep power-down mode wake-up pin with 20 ns glitch filter. Pull this pin HIGH externally before entering Deep power-down mode. Pull this pin LOW to exit Deep power-down mode. A LOW-going pulse as short as 50 ns wakes up the part.
				I	-	**AD5 —** A/D converter, input 5.
				O	-	**CT32B1_MAT3 —** Match output 3 for 32-bit timer 1.
PIO1_5/$\overline{\text{RTS}}$/ CT32B0_CAP0	45[3]	A3[3]	no	I/O	I; PU	**PIO1_5 —** General purpose digital input/output pin.
				O	-	**$\overline{\text{RTS}}$ —** Request To Send output for UART.
				I	-	**CT32B0_CAP0 —** Capture input 0 for 32-bit timer 0.
PIO1_6/RXD/ CT32B0_MAT0	46[3]	B3[3]	no	I/O	I; PU	**PIO1_6 —** General purpose digital input/output pin.
				I	-	**RXD —** Receiver input for UART.
				O	-	**CT32B0_MAT0 —** Match output 0 for 32-bit timer 0.
PIO1_7/TXD/ CT32B0_MAT1	47[3]	B2[3]	no	I/O	I; PU	**PIO1_7 —** General purpose digital input/output pin.
				O	-	**TXD —** Transmitter output for UART.
				O	-	**CT32B0_MAT1 —** Match output 1 for 32-bit timer 0.
PIO1_8/ CT16B1_CAP0	9[3]	F2[3]	no	I/O	I; PU	**PIO1_8 —** General purpose digital input/output pin.
				I	-	**CT16B1_CAP0 —** Capture input 0 for 16-bit timer 1.
PIO1_9/ CT16B1_MAT0/ MOSI1	17[3]	G4[3]	no	I/O	I; PU	**PIO1_9 —** General purpose digital input/output pin.
				O	-	**CT16B1_MAT0 —** Match output 0 for 16-bit timer 1.
				I/O	-	**MOSI1 —** Master Out Slave In for SPI1.
PIO1_10/AD6/ CT16B1_MAT1/ MISO1	30[5]	E8[5]	no	I/O	I; PU	**PIO1_10 —** General purpose digital input/output pin.
				I	-	**AD6 —** A/D converter, input 6.
				O	-	**CT16B1_MAT1 —** Match output 1 for 16-bit timer 1.
				I/O	-	**MISO1 —** Master In Slave Out for SPI1.
PIO1_11/AD7/ CT32B1_CAP1	42[5]	A5[5]	no	I/O	I; PU	**PIO1_11 —** General purpose digital input/output pin.
				I	-	**AD7 —** A/D converter, input 7.
				I	-	**CT32B1_CAP1 —** Capture input 1 for 32-bit timer 1.
PIO2_0 to PIO2_11				I/O		**Port 2 —** Port 2 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 2 pins depends on the function selected through the IOCONFIG register block.
PIO2_0/$\overline{\text{DTR}}$/SSEL1	2[3]	B1[3]	no	I/O	I; PU	**PIO2_0 —** General purpose digital input/output pin.
				O	-	**$\overline{\text{DTR}}$ —** Data Terminal Ready output for UART.
				I/O	-	**SSEL1 —** Slave Select for SPI1.
PIO2_1/$\overline{\text{DSR}}$/SCK1	13[3]	H1[3]	no	I/O	I; PU	**PIO2_1 —** General purpose digital input/output pin.
				I	-	**$\overline{\text{DSR}}$ —** Data Set Ready input for UART.
				I/O	-	**SCK1 —** Serial clock for SPI1.

Table 10. LPC1100XL series: LPC1113/14/15 pin description table (LQFP48 and TFBGA48 package) *…continued*

Symbol	LQFP48	TFBGA48	Start logic input	Type	Reset state [1]	Description
PIO2_2/$\overline{\text{DCD}}$/MISO1	26[3]	G8[3]	no	I/O	I; PU	**PIO2_2 —** General purpose digital input/output pin.
				I	-	**$\overline{\text{DCD}}$ —** Data Carrier Detect input for UART.
				I/O	-	**MISO1 —** Master In Slave Out for SPI1.
PIO2_3/$\overline{\text{RI}}$/MOSI1	38[3]	A7[3]	no	I/O	I; PU	**PIO2_3 —** General purpose digital input/output pin.
				I	-	**$\overline{\text{RI}}$ —** Ring Indicator input for UART.
				I/O	-	**MOSI1 —** Master Out Slave In for SPI1.
PIO2_4/ CT16B1_MAT1/ SSEL1	19[3]	G5[3]	no	I/O	I; PU	**PIO2_4 —** General purpose digital input/output pin.
				O	-	**CT16B1_MAT1 —** Match output 1 for 16-bit timer 1.
				O	-	**SSEL1 —** Slave Select for SPI1.
PIO2_5/ CT32B0_MAT0	20[3]	H5[3]	no	I/O	I; PU	**PIO2_5 —** General purpose digital input/output pin.
				O	-	**CT32B0_MAT0 —** Match output 0 for 32-bit timer 0.
PIO2_6/ CT32B0_MAT1	1[3]	A1[3]	no	I/O	I; PU	**PIO2_6 —** General purpose digital input/output pin.
				O	-	**CT32B0_MAT1 —** Match output 1 for 32-bit timer 0.
PIO2_7/ CT32B0_MAT2/RXD	11[3]	G2[3]	no	I/O	I; PU	**PIO2_7 —** General purpose digital input/output pin.
				O	-	**CT32B0_MAT2 —** Match output 2 for 32-bit timer 0.
				I	-	**RXD —** Receiver input for UART.
PIO2_8/ CT32B0_MAT3/TXD	12[3]	G1[3]	no	I/O	I; PU	**PIO2_8 —** General purpose digital input/output pin.
				O	-	**CT32B0_MAT3 —** Match output 3 for 32-bit timer 0.
				O	-	**TXD —** Transmitter output for UART.
PIO2_9/ CT32B0_CAP0	24[3]	H7[3]	no	I/O	I; PU	**PIO2_9 —** General purpose digital input/output pin.
				I	-	**CT32B0_CAP0 —** Capture input 0 for 32-bit timer 0.
PIO2_10	25[3]	H8[3]	no	I/O	I; PU	**PIO2_10 —** General purpose digital input/output pin.
PIO2_11/SCK0/ CT32B0_CAP1	31[3]	D7[3]	no	I/O	I; PU	**PIO2_11 —** General purpose digital input/output pin.
				I/O	-	**SCK0 —** Serial clock for SPI0.
				I	-	**CT32B0_CAP1 —** Capture input for 32-bit timer 0.
PIO3_0 to PIO3_5				I/O		**Port 3 —** Port 3 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 3 pins depends on the function selected through the IOCONFIG register block. Pins PIO3_6 to PIO3_11 are not available.
PIO3_0/$\overline{\text{DTR}}$/ CT16B0_MAT0/TXD	36[3]	B8[3]	no	I/O	I; PU	**PIO3_0 —** General purpose digital input/output pin.
				O	-	**$\overline{\text{DTR}}$ —** Data Terminal Ready output for UART.
				O	-	**CT16B0_MAT0 —** Match output 0 for 16-bit timer 0.
				O	-	**TXD —** Transmitter Output for UART.
PIO3_1/$\overline{\text{DSR}}$/ CT16B0_MAT1/RXD	37[3]	A8[3]	no	I/O	I; PU	**PIO3_1 —** General purpose digital input/output pin.
				I	-	**$\overline{\text{DSR}}$ —** Data Set Ready input for UART.
				O	-	**CT16B0_MAT1 —** Match output 1 for 16-bit timer 0.
				I	-	**RXD —** Receiver input for UART.

- Optional conversion on transition of input pin or timer match signal.
- Individual result registers for each ADC channel to reduce interrupt overhead.

7.12 General purpose external event counter/timers

The LPC1110/11/12/13/14/15 include two 32-bit counter/timers and two 16-bit counter/timers. The counter/timer is designed to count cycles of the system derived clock. It can optionally generate interrupts or perform other actions at specified timer values, based on four match registers. Each counter/timer also includes up to two capture inputs to trap the timer value when an input signal transitions, optionally generating an interrupt.

7.12.1 Features

- A 32-bit/16-bit timer/counter with a programmable 32-bit/16-bit prescaler.
- Counter or timer operation.
- Up to two capture channels per timer, that can take a snapshot of the timer value when an input signal transitions. A capture event may also generate an interrupt.
- The timer and prescaler may be configured to be cleared on a designated capture event. This feature permits easy pulse width measurement by clearing the timer on the leading edge of an input pulse and capturing the timer value on the trailing edge.
- Four match registers per timer that allow:
  - Continuous operation with optional interrupt generation on match.
  - Stop timer on match with optional interrupt generation.
  - Reset timer on match with optional interrupt generation.
- Up to four external outputs corresponding to match registers, with the following capabilities:
  - Set LOW on match.
  - Set HIGH on match.
  - Toggle on match.
  - Do nothing on match.

7.13 System tick timer

The ARM Cortex-M0 includes a system tick timer (SYSTICK) that is intended to generate a dedicated SYSTICK exception at a fixed time interval (typically 10 ms).

7.14 Watchdog timer (LPC1100 series, LPC111x/101/201/301)

Remark: The watchdog timer without windowed features is available on parts LPC111x/101/201/301.

The purpose of the watchdog is to reset the microcontroller within a selectable time period.

7.14.1 Features

- Internally resets chip if not periodically reloaded.
- Debug mode.

- Enabled by software but requires a hardware reset or a watchdog reset/interrupt to be disabled.
- Incorrect/Incomplete feed sequence causes reset/interrupt if enabled.
- Flag to indicate watchdog reset.
- Programmable 24-bit timer with internal prescaler.
- Selectable time period from ($T_{cy(WDCLK)} \times 256 \times 4$) to ($T_{cy(WDCLK)} \times 2^{24} \times 4$) in multiples of $T_{cy(WDCLK)} \times 4$.
- The Watchdog Clock (WDCLK) source can be selected from the Internal RC oscillator (IRC), the Watchdog oscillator, or the main clock. This gives a wide range of potential timing choices of Watchdog operation under different power reduction conditions. It also provides the ability to run the WDT from an entirely internal source that is not dependent on an external crystal and its associated components and wiring for increased reliability.

7.15 Windowed WatchDog Timer (LPC1100L and LPC1100XL series)

Remark: The windowed watchdog timer is available on the LPC1100L and LPC1100XL series only.

The purpose of the watchdog is to reset the controller if software fails to periodically service it within a programmable time window.

7.15.1 Features

- Internally resets chip if not periodically reloaded during the programmable time-out period.
- Optional windowed operation requires reload to occur between a minimum and maximum time period, both programmable.
- Optional warning interrupt can be generated at a programmable time prior to watchdog time-out.
- Enabled by software but requires a hardware reset or a watchdog reset/interrupt to be disabled.
- Incorrect feed sequence causes reset or interrupt if enabled.
- Flag to indicate watchdog reset.
- Programmable 24-bit timer with internal prescaler.
- Selectable time period from ($T_{cy(WDCLK)} \times 256 \times 4$) to ($T_{cy(WDCLK)} \times 2^{24} \times 4$) in multiples of $T_{cy(WDCLK)} \times 4$.
- The Watchdog Clock (WDCLK) source can be selected from the IRC or the dedicated watchdog oscillator (WDO). This gives a wide range of potential timing choices of watchdog operation under different power conditions.

7.16 Clocking and power control

7.16.1 Crystal oscillators

The LPC1110/11/12/13/14/15 include three independent oscillators. These are the system oscillator, the Internal RC oscillator (IRC), and the Watchdog oscillator. Each oscillator can be used for more than one purpose as required in a particular application.

The system oscillator operates at frequencies of 1 MHz to 25 MHz. This frequency can be boosted to a higher frequency, up to the maximum CPU operating frequency, by the system PLL.

7.16.1.3 Watchdog oscillator

The watchdog oscillator can be used as a clock source that directly drives the CPU, the watchdog timer, or the CLKOUT pin. The watchdog oscillator nominal frequency is programmable between 9.4 kHz and 2.3 MHz. The frequency spread over processing and temperature is ±40 %.

7.16.2 System PLL

The PLL accepts an input clock frequency in the range of 10 MHz to 25 MHz. The input frequency is multiplied up to a high frequency with a Current Controlled Oscillator (CCO). The multiplier can be an integer value from 1 to 32. The CCO operates in the range of 156 MHz to 320 MHz, so there is an additional divider in the loop to keep the CCO within its frequency range while the PLL is providing the desired output frequency. The PLL output frequency must be lower than 100 MHz. The output divider may be set to divide by 2, 4, 8, or 16 to produce the output clock. Since the minimum output divider value is 2, it is insured that the PLL output has a 50 % duty cycle. The PLL is turned off and bypassed following a chip reset and may be enabled by software. The program must configure and activate the PLL, wait for the PLL to lock, and then connect to the PLL as a clock source. The PLL settling time is 100 μs.

7.16.3 Clock output

The LPC1110/11/12/13/14/15 features a clock output function that routes the IRC oscillator, the system oscillator, the watchdog oscillator, or the main clock to an output pin.

7.16.4 Wake-up process

The LPC1110/11/12/13/14/15 begin operation at power-up and when awakened from Deep power-down mode by using the 12 MHz IRC oscillator as the clock source. This allows chip operation to resume quickly. If the system oscillator or the PLL is needed by the application, software will need to enable these features and wait for them to stabilize before they are used as a clock source.

7.16.5 Power control

The LPC1110/11/12/13/14/15 support a variety of power control features. There are three special modes of processor power reduction: Sleep mode, Deep-sleep mode, and Deep power-down mode. The CPU clock rate may also be controlled as needed by changing clock sources, reconfiguring PLL values, and/or altering the CPU clock divider value. This allows a trade-off of power versus processing speed based on application requirements. In addition, a register is provided for shutting down the clocks to individual on-chip peripherals, allowing fine tuning of power consumption by eliminating all dynamic power use in any peripherals that are not required for the application. Selected peripherals have their own clock divider which provides even better power control.

7.16.5.1 Power profiles (LPC1100L and LPC1100XL series only)

The power consumption in Active and Sleep modes can be optimized for the application through simple calls to the power profile. The power configuration routine configures the LPC1110/11/12/13/14/15 for one of the following power modes:

9. Thermal characteristics

The average chip junction temperature, T_j (°C), can be calculated using the following equation:

$$T_j = T_{amb} + (P_D \times R_{th(j-a)}) \quad (1)$$

- T_{amb} = ambient temperature (°C),
- $R_{th(j-a)}$ = the package junction-to-ambient thermal resistance (°C/W)
- P_D = sum of internal and I/O power dissipation

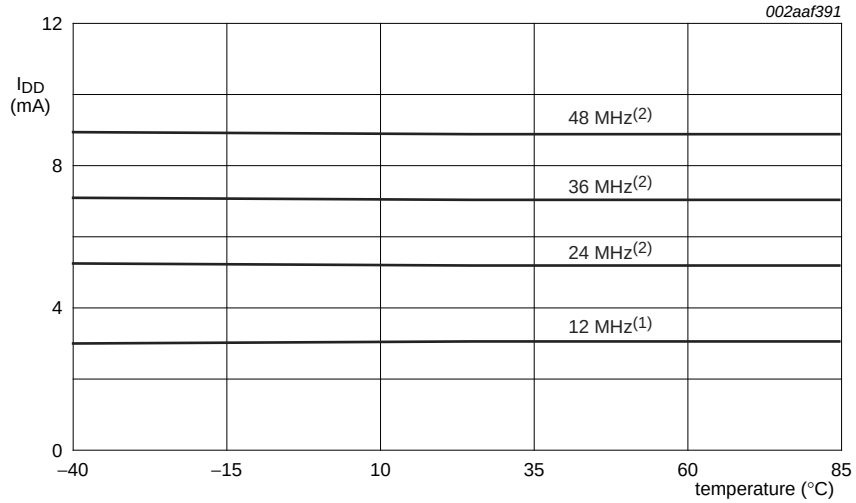
The internal power dissipation is the product of I_{DD} and V_{DD}. The I/O power dissipation of the I/O pins is often small and many times can be negligible. However it can be significant in some applications.

Table 13. Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$T_{j(max)}$	maximum junction temperature		-	-	125	°C

Table 14. LPC111x/x01 Thermal resistance value (°C/W): ±15 %

HVQFN33		**LQFP48**	
θ**ja**		θ**ja**	
JEDEC (4.5 in × 4 in)		**JEDEC (4.5 in × 4 in)**	
0 m/s	40.4	0 m/s	82.1
1 m/s	32.7	1 m/s	73.7
2.5 m/s	28.3	2.5 m/s	68.2
Single-layer (4.5 in × 3 in)		**8-layer (4.5 in × 3 in)**	
0 m/s	84.8	0 m/s	115.2
1 m/s	61.6	1 m/s	94.7
2.5 m/s	53.1	2.5 m/s	86.3
θjc	20.3	θjc	29.6
θjb	1.1	θjb	34.2

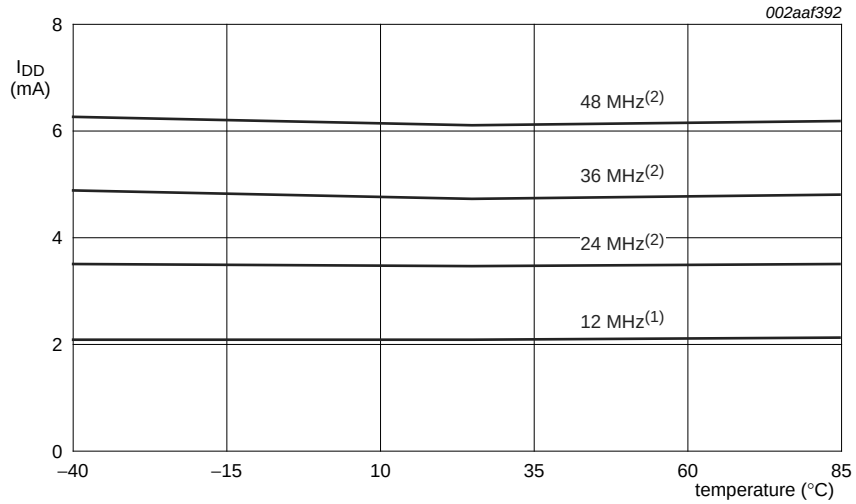


Conditions: V_{DD} = 3.3 V; active mode entered executing code `while(1){}` from flash; all peripherals disabled in the SYSAHBCLKCTRL register (SYSAHBCLKCTRL = 0x1F); all peripheral clocks disabled; internal pull-up resistors disabled; BOD disabled.

(1) System oscillator and system PLL disabled; IRC enabled.

(2) System oscillator and system PLL enabled; IRC disabled.

Fig 19. Active mode: Typical supply current I_{DD} versus temperature for different system clock frequencies (for LPC111x/101/201/301)



Conditions: V_{DD} = 3.3 V; sleep mode entered from flash; all peripherals disabled in the SYSAHBCLKCTRL register (SYSAHBCLKCTRL = 0x1F); all peripheral clocks disabled; internal pull-up resistors disabled; BOD disabled.

(1) System oscillator and system PLL disabled; IRC enabled.

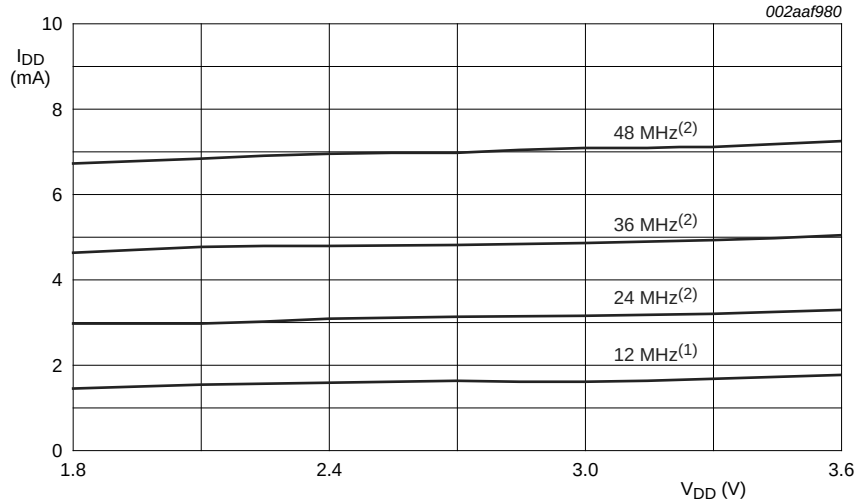
(2) System oscillator and system PLL enabled; IRC disabled.

Fig 20. Sleep mode: Typical supply current I_{DD} versus temperature for different system clock frequencies (for LPC111x/101/201/301)

10.6 Power consumption LPC1100L series (LPC111x/002/102/202/302)

Power measurements in Active, Sleep, and Deep-sleep modes were performed under the following conditions (see *LPC111x user manual*):

- Configure all pins as GPIO with pull-up resistor disabled in the IOCONFIG block.
- Configure GPIO pins as outputs using the GPIOnDIR registers.
- Write 0 to all GPIOnDATA registers to drive the outputs LOW.

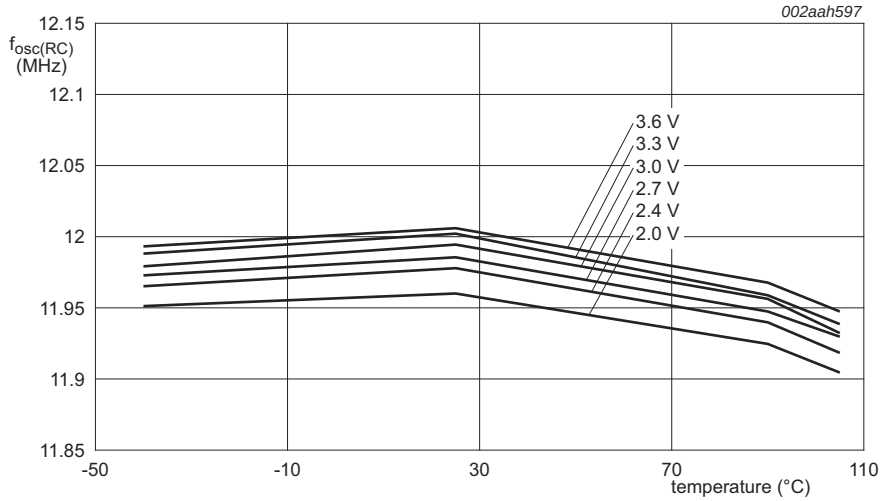


Conditions: T_{amb} = 25 °C; active mode entered executing code `while(1){}` from flash; all peripherals disabled in the SYSAHBCLKCTRL register (SYSAHBCLKCTRL = 0x1F); all peripheral clocks disabled; internal pull-up resistors disabled; BOD disabled; low-current mode.

(1) System oscillator and system PLL disabled; IRC enabled.

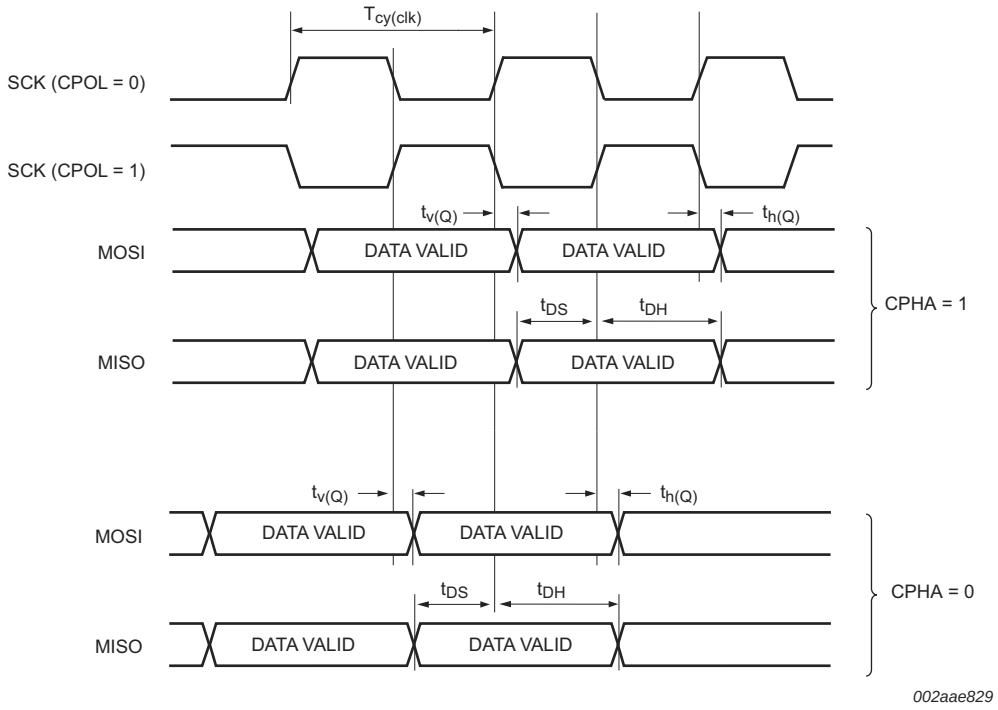
(2) System oscillator and system PLL enabled; IRC disabled.

Fig 23. Active mode: Typical supply current I_{DD} versus supply voltage V_{DD} for different system clock frequencies (for LPC111x/002/102/202/302)



Conditions: Frequency values are typical values. 12 MHz ± 1 % accuracy is guaranteed for 2.7 V ≤ V_{DD} ≤ 3.6 V and T_{amb} = −40 °C to +105 °C. Variations between parts may cause the IRC to fall outside the 12 MHz ± 1 % accuracy specification for voltages below 2.7 V.

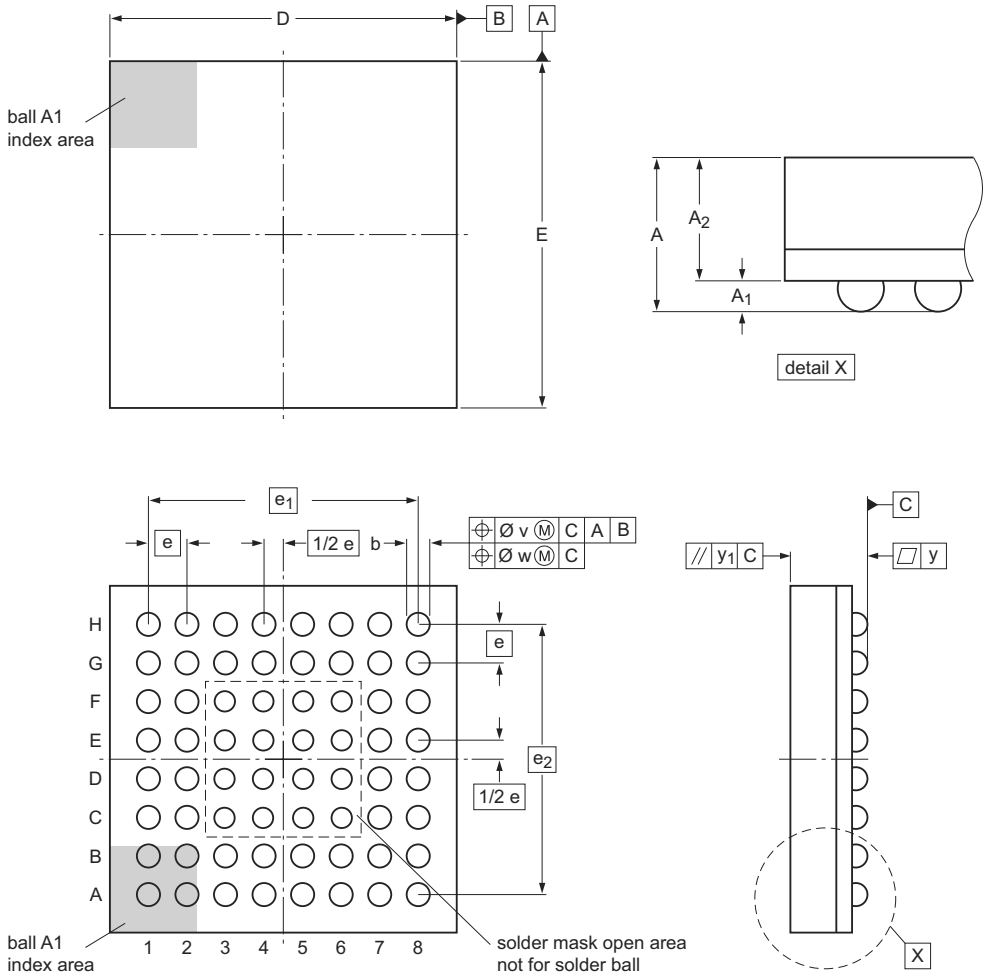
Fig 45. Internal RC oscillator frequency versus temperature (J parts)



Pin names SCK, MISO, and MOSI refer to pins for both SPI peripherals, SPI0 and SPI1.

Fig 47. SPI master timing in SPI mode

TFBGA48: plastic thin fine-pitch ball grid array package; 48 balls; body 4.5 x 4.5 x 0.7 mm **SOT1155-2**



Dimensions

Unit	A	A_1	A_2	b	D	E	e	e_1	e_2	v	w	y	y_1
max	1.10	0.30	0.80	0.35	4.6	4.6							
mm nom	0.95	0.25	0.70	0.30	4.5	4.5	0.5	3.5	3.5	0.15	0.05	0.08	0.1
min	0.85	0.20	0.65	0.25	4.4	4.4							

sot1155-2_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT1155-2		- - -				~~13-06-17~~ 13-06-19

Fig 62. Package outline TFBGA48 (SOT1155-2)

14. Soldering

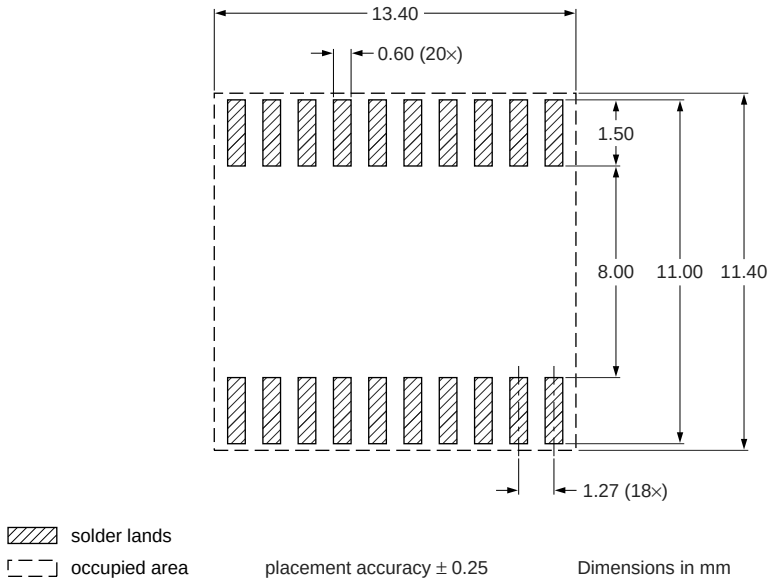
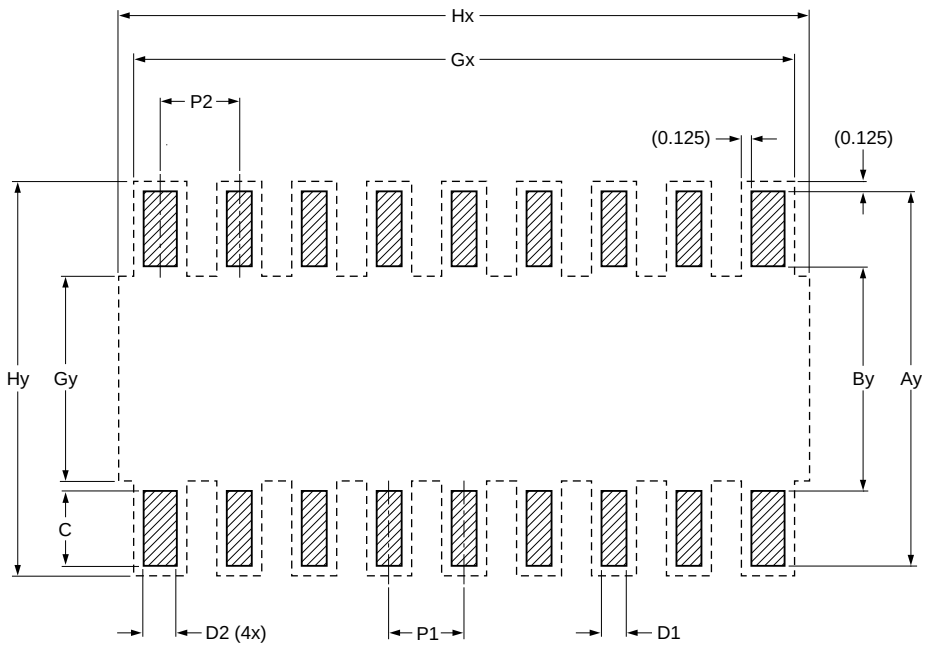


Fig 63. Reflow soldering of the SO20 package

Footprint information for reflow soldering of TSSOP28 package **SOT361-1**



Generic footprint pattern

Refer to the package outline drawing for actual layout

solder land

occupied area

DIMENSIONS in mm

P1	P2	Ay	By	C	D1	D2	Gx	Gy	Hx	Hy
0.650	0.750	7.200	4.500	1.350	0.400	0.600	9.500	5.300	11.800	7.450

sot361-1_fr

Fig 65. Reflow soldering of the TSSOP28 package